IPC ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
Supplier Inform	nation														
Company name*			Company unique ID			ī	Unique ID Authority				Respon	Response Date*			
nsemi											2023-0	2023-06-08			
Contact Name			Title - Contact			1	Phone - Contact*				Email	Email - Contact*			
Product-Env-Stew	ards		Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized Repres	entative*	Title - Representative			1	Phone - Representative*				Email	Email - Representative*				
Product-Env-Stew	ards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Request	Requester Item Number Mfr Ite		Item Number Mfr Item Name				Effective Dat	te Vers	ion	Manufacturing Site		Weight*	UOM	Unit Type	
		KDT00030ATR ALS CHIPL		ALS CHIPLED S	LED SMD ILK 100NA		2023-06-08			EVERLGFG		1.284	mg	Each	
	Process Information				(AMD 000 M						1.5		(D. 0)		
			, and the same of		I-STD-020 MS	SL Rating			s Body Temperature   Max Time at Peak				ber of Reflow Cyc	eles	
<u> </u>	n (Sn) - annealed	C	CU Alloy	3	3		260		C	30	seco	onds 3			
omments															
	L 3 Rated item requires E		•												
or more informati	on regarding material co	mposition ]	please refer to	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the					
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight Unit of Measure		Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.35	mg	Supplier	Silicon (Si)	7440-21-3		0.35	mg
Die Attach	0.05	mg	Supplier	Silver (Ag)	7440-22-4		0.0435	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.0065	mg
Mold Compound-Black	0.4	mg	Supplier	1,2,3,6-Tetrahydrophthalic acid anhydride	85-43-8		0.16	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.24	mg
PCB	0.474		Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.004	mg
			Supplier	Fiber Glass (SiO2)	65997-17-3		0.354	mg
			Supplier	Gold (Au)	7440-57-5		0.001	mg
			Supplier	Copper (Cu)	7440-50-8		0.1121	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7		0.003	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg